TTape[™] Platform **Datasheet**

Pressure sensitive adhesive

<1s response for temperature</p>

Extremely thin device suitable

Increased spatial resolution of

for conformal installation

temperature monitoring

for simple and quick

AEC-Q200 Qualified

installation

monitoring

TTP Series Distributed Temperature Monitoring Platform

RoHS 🔊 HF



Web Resources



Download ECAD models, order samples, and find technical recources at <u>www.littelfuse.com</u>

Electrical Specifications

Recommended operating conditions

Name	Description	Value	Units
V _{DD}	Power supply range	3.3 to 5.5	V
Rp	Pull up resistor value when $V_{DD} = 3.3$ to 5.5 V	200 (±5%)	kΩ

Absolute maximum ratings

5			
Name	Description	Value	Units
V _{max}	Voltage	6	V
I _{max}	Current	6	mA
-	Dielectric withstand. Tested per MIL-STD-202 Test Method 301	2500	V
-	Minimum bend radius	1	mm

Description

The TTape[™] platform is a distributed temperature monitoring technology for battery packs that helps to improve the detection of localized cell overheating. This device helps to increase the lifetime of batteries and provides thermal runaway protection.

Features

- Simple integration with existing BMS solutions complementing NTCs
- No calibration or temperature look-up tables needed

Benefits

- Over-temperature monitoring of many cells or large area with single MCU input
- Helps the MCU to wake from sleep mode at overtemperature events
- Applications
- Li-ion battery packs
- Large area, distributed, temperature monitoring

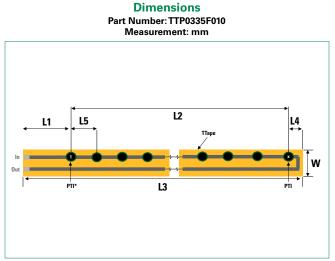
Operating Conditions

Device continues to meet all specifications and performance criteria System capable of detecting $T_{\rm L1}$

Specification	Value	Units
Operating temperature	-40 to +85	°C
Storage temperature	-40 to +55	°C
Pressure on PTI	<1500	Pa



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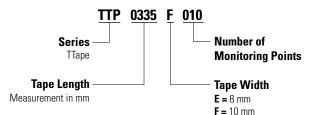
Note:

* Printed Temperature Indicator (Monitoring Point or Individual Sensing Element on TTape device)

Parameter		TTP 0335 F 010 sample	Customized design
Number of Printed Thermal Indicators (PTIs)		10	≤50
Position of the first thermal indicator from the tape edge	L1	45±0,5 mm	≥15 mm
Distance between first and last thermal indicator	L2	274±0,5 mm	depending on design
TTape device total length	L3	337±0,5 mm	<1 m (typical)*
Distance between the last thermal indicator and the end of the tape	L4	17 mm±0,5 mm	≥10 mm
Pitch between Printed Thermal Indicators (PTIs) (can vary from PTI to PTI)	L5	30 mm±0,5 mm	≥10 mm
Tape width	W	10±0,5 mm	8 mm
Diameter of Printed Thermal Indicators (PTIs)		≤5 mm	≤5 mm
Device Thickness		< 500 µm	< 500 µm

Note: * < 8 m (stitching option available)

Part Numbering System

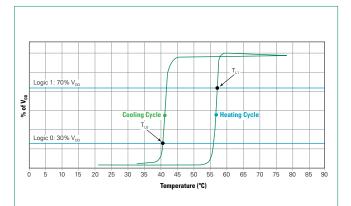


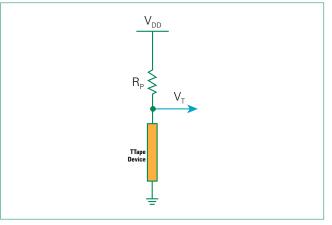
Notes:

Part number and dimensions are for standard sample devices.

TTape device will be customized to the geometrical needs of the application.

Temperature Indication Characteristics





Name	Temperature (°C) ¹		
Name	Typical 2,3	Tolerance	Description
T _{L1}	58	± 3	Logic value one occurs when temperature is equal or higher than this value during heating
TLO	42	± 3	Logic value zero occurs when cooling

Notes:

1. Using 10-bit or better A/D recommended

2. Specification applies when less than 11 monitoring Points are heated and cooled simultaneously. Typical values for T_{L1} and T_{L0} decrease approximately 3 °C when simultaneously heating and cooling between 11 and 25 Monitoring Points.

3. After performing AEC-0200 'Biased Humidity' test, which applies 85 °C at 85% relative humidity for 1000 hours, trip temperature will decrease. T_{L1} will be greater than 45 °C and T_{L0} will be greater than 30 °C.

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